



CCD VERTICAL DRIVER FOR DIGITAL CAMERAS

FEATURES

- CCD Vertical Driver:
 - Three Field CCD Support
 - Two Field CCD Support
- Output Drivers:
 - 3 Levels Driver (V-Transfer) x 5
 - 2 Levels Driver (V-Transfer) x 3
 - 2 Levels Driver (E-Shutter) x 1
- Drive Capability: - 450 pF to 1890 pF With 60 Ω to 240 Ω
- Input Phase:
 - 3 State (V-Transfer) x 5
 - 2 State (V-Transfer) x 3
 - 2 State (E-Shutter) x 1
- Portable Operation:
 - Input Interface: 2.7 V to 5.5 V

- . **Power Supply:**
 - VDD 2.7 V to 5.5 V – VL
 - -5 V to -9 V
 - VM GND
 - VH 11.5V to 15.5 V

APPLICATIONS

- **Digital Camera**
- Video Camera •

DESCRIPTION

The VSP1900 is a CCD vertical clock driver with electricshutter support. This device is composed of eight vertical transfer channels, which support both 3-field CCD and 2-field CCD operation. The VSP1900 contributes low power consumption and parts number reduction in the system.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

VSP1900



SLES062 - MARCH 2003



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

ORDERING INFORMATION

PRODUCT	PACKAGE	PACKAGE DESIGNATOR	OPERATING TEMPERATURE RANGE	PACKAGE MARKING	ORDERING NUMBER	TRANSPORT MEDIA
1001000	TOOODOO	DDT	25°C to 85°C	V6D1000	V0D4000	Tube (60 units/tube)
VSP1900	TSSOP30	DBT	–25°C to 85°C	VSP1900	VSP1900	Tape and reel

(1) For the most current specification and package information, refer to our web site at www.ti.com.

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range unless otherwise noted⁽¹⁾

		UNITS
	VDD	GND -0.3 V to 7 V
Supply voltage	VL	GND to -10 V
	VH	VL + 26 V
Input voltage, VIN		GND –0.3 V to (VDD + 0.3 V)
Ambient temperature under bias		–25°C to 85°C
Storage temperature, T _{Stg}		–55°C to 150°C
Junctiontemperature		150°C
Package temperature (IR reflow, peak)		235°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

free-air temperature range unless otherwise noted

	MI	NOM	MAX	UNIT
Supply voltage, VDD	2.	7	5.5	V
Supply voltage, VL	-	5	-9	V
Supply voltage, VH	11.	5	15.5	V
		GND – 0.3		
Input voltage, VIN		to (VDD + 0.3)		V

TRUTH TABLE

INPUT					OUTPUT	
V1N V3AN V3BN V5AN V5BN	CH1N CH2N CH3N CH4N CH5N	V2N V4N V6N	SUBN	V1 V3A V3B V5A V5B	V2 V4 V6	SUB
L	L	Х	Х	VH	Х	Х
L	Н	Х	Х	VM	Х	Х
Н	L	Х	Х	Z	Х	X
Н	Н	Х	Х	VL	Х	Х
Х	Х	L	Х	Х	VM	Х
Х	Х	Н	Х	Х	VL	Х
Х	Х	Х	L	Х	Х	VH
Х	Х	Х	Н	Х	Х	VL

NOTE: Z = High impedance X = Don't care

ELECTRICAL CHARACTERISTICS

all specifications at $T_A = 25^{\circ}C$ (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
	DC power consumption			5.3		mW
	Switching power consumption	VSP2267 (TG) with loading diagram		550		mW
DC CHA	RACTERISTICS					
VIH	High-level input voltage		0.7VDD			V
VIL	Low-level input voltage				0.2VDD	V
IIN	Inputcurrent	V_{IN} = GND to 5 V (without pullup / pulldown resistor)	-10	0	10	
		V _{IN} = GND to 5 V (pullup / pulldown resistor)	-625	0	625	μA
ΙΗ				0.1	0.2	
IDD	Operating supply current			1		mA
۱L				0.125		
IOL		V1, V2, V3A, V3B, V4, V5A, V5B, V6 = -8.1 V	10			
IOM1		V1, V2, V3A, V3B, V4, V5A, V5B, V6 = -0.2 V			-5	
IOM2		V1, V3A, V3B, V5A, V5B = 0.2 V	5			
IOH	Output current	V1, V3A, V3B, V5A, V5B = 14.55 V			-7.2	mA
IOSL		SUB = -8.1 V	5.4			
IOSH		SUB = 14.55 V			-4	

SWITCHING CHARACTERISTICS

all specifications at T_A = 25°C (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
^t d(PLM)				15	100	
^t d(PMH)				20	100	
^t d(PLH)	Dran a motion de la utina a			20	100	
^t d(PML)	Propagation delay time			15	50	ns
^t d(PHM)				30	50	
^t d(PHL)				30	50	
^t r(TLM)		$VL \rightarrow VM$			300	
^t r(TMH)	Rise time	$VM\toVH$			300	ns
^t r(TLH)		$VL\toVH$			300	
^t f(TML)		$VM\toVL$			300	
^t f(THM)	Falltime	$VH\toVM$			300	ns
^t f(THL)		$VH\toVL$			300	
V _{n(CLH)}						
V _{n(CLL)}						
V _{n(CMH)}	Output noise voltage				2	V
V _{n(CML)}						
V _{n(CHL)}						



PIN ASSIGNMENTS



Terminal Functions

TERMINAL		TYPE	DESCRIPTIONS
NAME	NO.	TIFE	DESCRIPTIONS
GND	1	Р	Ground
SUBN	2	DI	CCD substrate clock SUB input
V2N	3	DI	Vertical transfer clock 2 input
V4N	4	DI	Vertical transfer clock 4 input
V6N	5	DI	Vertical transfer clock 6 input
DVDD	6	Р	Digital power supply
V5BN	7	DI	Vertical transfer clock 5B input
CH5N	8	DI	Read out clock 5 input
CH1N	9	DI	Read out clock 1 input
V1N	10	DI	Vertical transfer clock 1 input
CH2N	11	DI	Read out clock 2 input
V3AN	12	DI	Vertical transfer clock 3A input
V5AN	13	DI	Vertical transfer clock 5A input
CH3N	14	DI	Read out clock 3 input
GND	15	Р	Ground
V3BN	16	DI	Vertical transfer clock 3B input
CH4N	17	DI	Read out clock 4 input
VL	18	Р	Digital power supply
V3B	19	DO	Vertical transfer clock 3B output
V5A	20	DO	Vertical transfer clock 5A output
V3A	21	DO	Vertical transfer clock 3A output
V1	22	DO	Vertical transfer clock 1 output
VH	23	Р	Digital power supply
V5B	24	DO	Vertical transfer clock 5B output
V6	25	DO	Vertical transfer clock 6 output
V4	26	DO	Vertical transfer clock 4 output
V2	27	DO	Vertical transfer clock 2 output
SUB	28	DO	CCD substrate clock SUB output
GND	29	Р	Ground
GND	30	Р	Ground

FUNCTIONAL BLOCK DIAGRAM



VSP1900







LOADING DIAGRAM

	R1, R2, R4, R6	60 Ω
Vertical clock series resistor	R3A, R5A	240 Ω
	R3B, R5B	80 Ω
	CΦV1	1280 pF
	CΦV3A, CΦV3B	640 pF
Vertical clock to GND	CΦV5A, CΦV5B	640 pF
	CΦV2, CΦV4, CΦV6	400 pF
	CΦV12	510 pF
	СФV23А, СФV23В	50 pF
-	СФV45А, СФV45В	50 pF
Between vertical clock	СФV3А4, СФV3В4	260 pF
	CΦV5A6, CΦV5B6	260 pF
	CΦV61	100 pF
Substrate clock to GND	CΦVSUB	1000 pF
Vertical clock GND resistor	R GND	18 Ω





DESCRIPTION

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FRUMENTS www.ti.com

OPERATION

Power On/Off Sequence

This is the same as the CCD power up sequence, when power on, VDD powers on first VH, VM power on second, and VL powers on later. When powering off, VL powers off first, VH, VM power of second, and VDD powers off later.

Vertical Transfer Signal

The VSP1900 receives signals from TG (CCD timing generator). The input signal is converted into CCD operation voltage level by the level shifter. The level shifter circuits connect to a 2-state or 3-state driver, which is connected to the CCD input pin. While using a 2-field CCD, one of the 3-state drivers is used as a 2-state driver. The CH#N pin is pulled up internally, so that the VH level does not appear on the output pin.



Figure 2. FVSP1900 Circuit Application



MECHANICAL DATA

DBT (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

30 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion.
- D. Falls within JEDEC MO-153

MECHANICAL DATA

MPDS019D - FEBRUARY 1996 - REVISED FEBRUARY 2002

DBT (R-PDSO-G**)

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